

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Daniel F. Sievenpiper,	)	Re: Preliminary Amendment
et al.	)	
	)	
Serial No.: Not yet assigned	)	
Filed: concurrently herewith	)	
	)	
Divisional of USSN 09/905,794	)	
filed on July 13, 2001	)	Our Ref: B-4046DIV 621280-9
	)	
For: "MOLDED HIGH IMPEDANCE SURFACE	)	
AND A METHOD OF MAKING SAME"	)	Date: December 5, 2003

**PRELIMINARY AMENDMENT**

Mail Stop Patent Application  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

The above-identified application is a divisional of pending prior U.S. Patent Application Serial No. 09/905,794 filed on July 13, 2001. This paper is being filed as a Preliminary Amendment to the above-identified Application being filed concurrently herewith. Please amend the above-identified application as described below. **All amendments and remarks herein are made without prejudice.**

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** begin on page 3 of this paper.

**Amendments to the Drawings** begin on page 6 of this paper and include an attached replacement sheet.

**Remarks/Arguments** begin on page 7 of this paper.